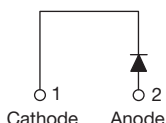


# Hyperfast Rectifier, 15 A FRED Pt®



2L TO-220 FullPAK



VS-15ETH06FP-N3

## FEATURES

- Hyperfast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Single die center tap module
- Fully isolated package ( $V_{INS} = 2500 V_{RMS}$ )
- UL pending
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

## PRIMARY CHARACTERISTICS

$I_{F(AV)}$	15 A
$V_R$	600 V
$V_F$ at $I_F$	1.3 V
$t_{rr}$ typ.	22 ns
$T_J$ max.	175 °C
Package	2L TO-220 FullPAK
Circuit configuration	Single

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	$V_{RRM}$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 80\text{ °C}$	15	A
Non-repetitive peak surge current	$I_{FSM}$	$T_J = 25\text{ °C}$	180	
Peak repetitive forward current	$I_{FM}$		30	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-65 to +175	°C

## ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100\text{ }\mu A$	600	-	-	V
Forward voltage	$V_F$	$I_F = 15\text{ A}$	-	1.8	2.2	
		$I_F = 15\text{ A}, T_J = 150\text{ °C}$	-	1.3	1.6	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	0.2	50	$\mu A$
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	30	500	
Junction capacitance	$C_T$	$V_R = 600\text{ V}$	-	20	-	pF
Series inductance	$L_S$	Measured lead to lead 5 mm from package body	-	8.0	-	nH

**DYNAMIC RECOVERY CHARACTERISTICS** ( $T_C = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	22	30	ns
		$I_F = 15\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	28	35	
		$T_J = 25\text{ }^{\circ}\text{C}$	-	29	-	
		$T_J = 125\text{ }^{\circ}\text{C}$	-	75	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	3.5	-	A
		$T_J = 125\text{ }^{\circ}\text{C}$	-	7	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	57	-	nC
		$T_J = 125\text{ }^{\circ}\text{C}$	-	300	-	
Reverse recovery time	$t_{rr}$	$I_F = 15\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 390\text{ V}$	-	51	-	ns
Peak recovery current	$I_{RRM}$	$T_J = 125\text{ }^{\circ}\text{C}$	-	20	-	A
Reverse recovery charge	$Q_{rr}$	$T_J = 125\text{ }^{\circ}\text{C}$	-	580	-	nC

**THERMAL MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J$ , $T_{Stg}$		-65	-	175	$^{\circ}\text{C}$
Thermal resistance, junction-to-case	$R_{thJC}$		-	3.0	3.5	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction-to-ambient per leg	$R_{thJA}$	Typical socket mount	-	-	70	
Thermal resistance, case-to-heatsink	$R_{thCS}$	Mounting surface, flat, smooth, and greased	-	0.5	-	
Weight			-	2.0	-	g
			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style 2L TO-220 FullPAK	15ETH06FP			

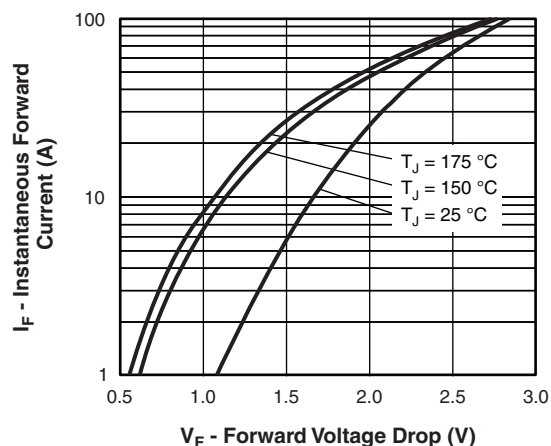


Fig. 1 - Typical Forward Voltage Drop Characteristics

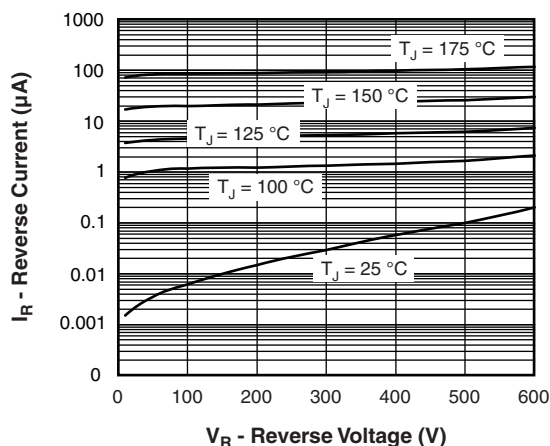


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

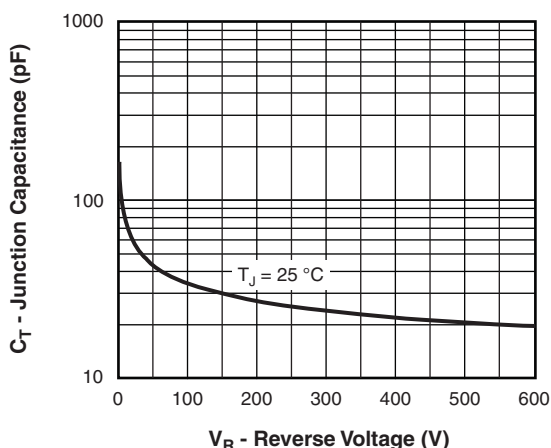


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

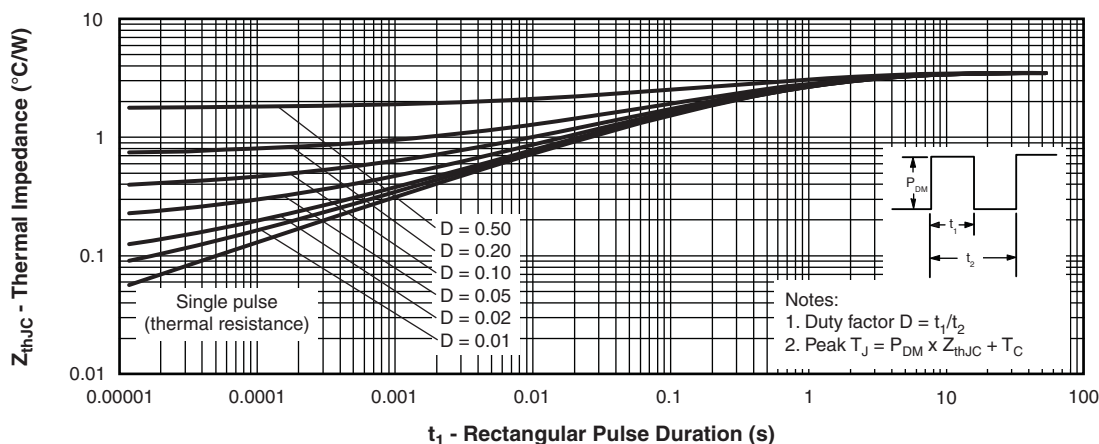
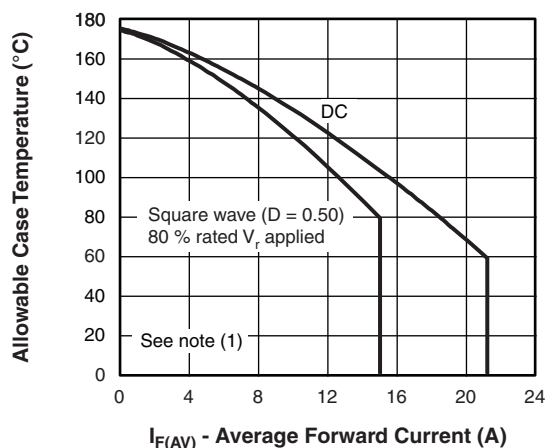

Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

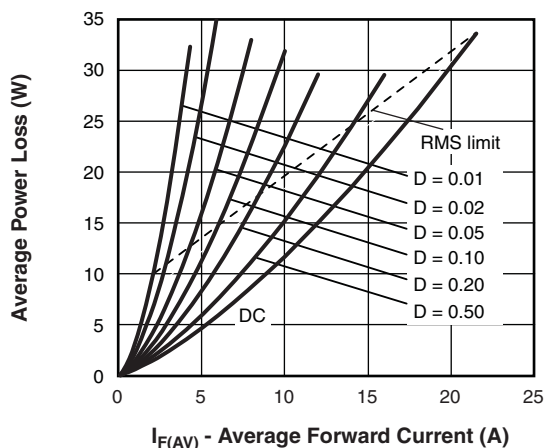


Fig. 6 - Forward Power Loss Characteristics

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$

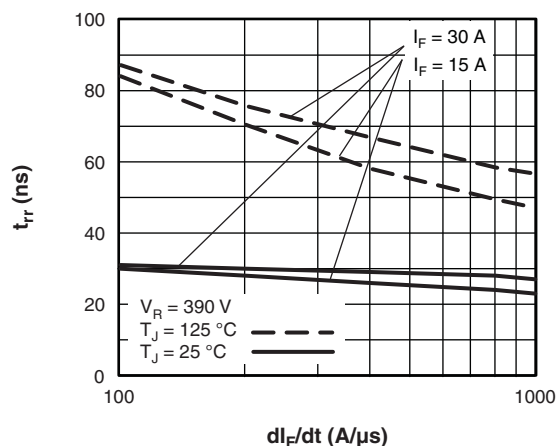
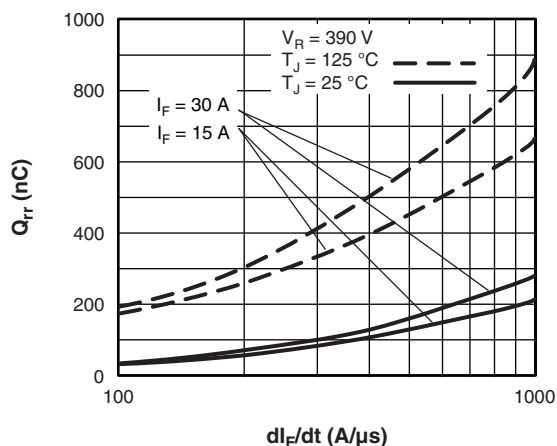
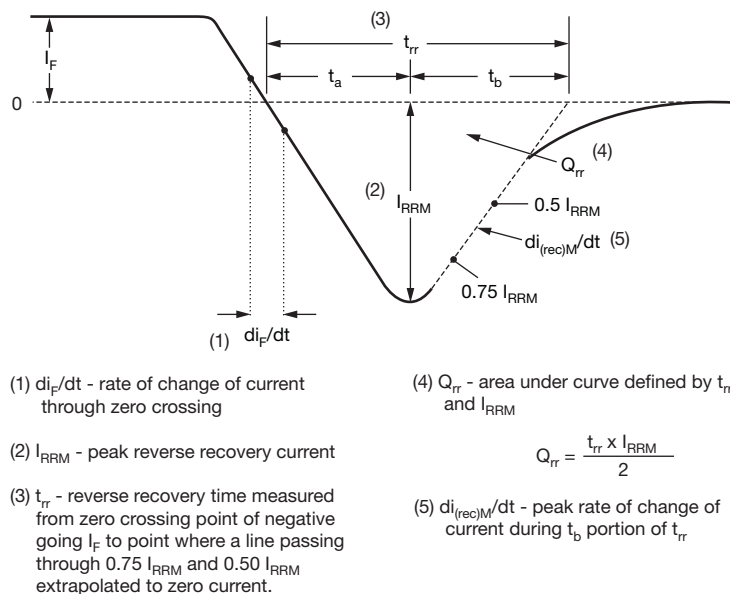

Fig. 7 - Typical Reverse Recovery Time vs.  $di_F/dt$ 

Fig. 8 - Typical Stored Charge vs.  $di_F/dt$ 


Fig. 9 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE

Device code	VS-	15	E	T	H	06	FP	-N3
	1	2	3	4	5	6	7	8

- |   |   |  |
|---|---|--|
| 1 | - | Vishay Semiconductors product  |
| 2 | - | Current rating (15 = 15 A)   |
| 3 | - | E = single   |
| 4 | - | T = TO-220, D <sup>2</sup> PAK (TO-263AB)  |
| 5 | - | H = hyperfast recovery   |
| 6 | - | Voltage rating (06 = 600 V)  |
| 7 | - | FP = 2L TO-220 FullPAK   |
| 8 | - | Environmental digit:<br>-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free |

### ORDERING INFORMATION (Example)

PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-15ETH06FP-N3	50	1000	Antistatic plastic tube

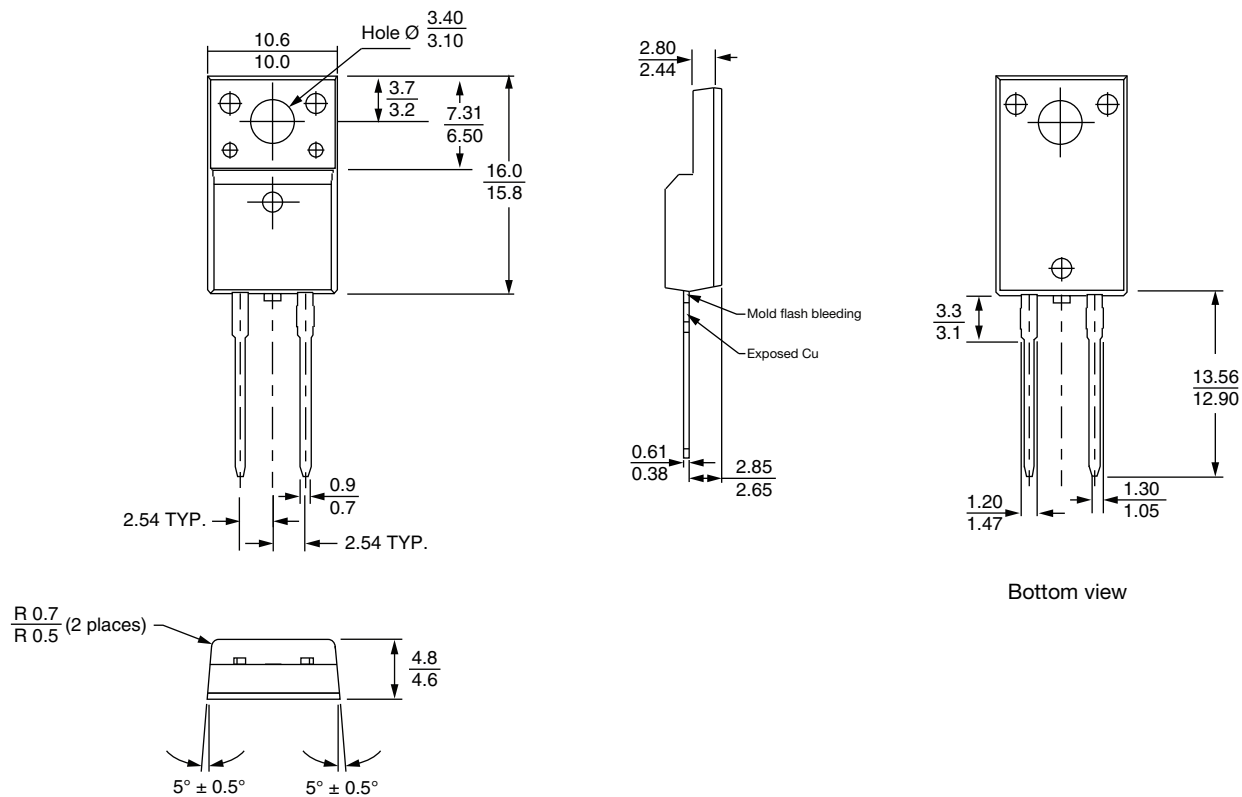
### LINKS TO RELATED DOCUMENTS

Dimensions	<a href="http://www.vishay.com/doc?96157">www.vishay.com/doc?96157</a>
Part marking information	<a href="http://www.vishay.com/doc?95392">www.vishay.com/doc?95392</a>
SPIICE model	<a href="http://www.vishay.com/doc?96618">www.vishay.com/doc?96618</a>



## 2L TO-220 FullPAK

**DIMENSIONS** in millimeters





## Disclaimer

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